

3N60Z

3A, 600V N-CHANNEL POWER MOSFET

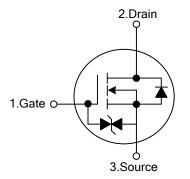
DESCRIPTION

The UTC **3N60Z** is a high voltage and high current power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ = 3.6 Ω @V_{GS} = 10 V
- * Ultra low gate charge (typical 10 nC)
- * Low reverse transfer capacitance (C_{RSS} = typical 5.5 pF)
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

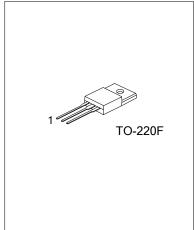
SYMBOL



ORDERING INFORMATION

Ordering Number			Daakaga	Pin Assignment			Dooking	
Lead Free	Halogen Free		Package	1	2	3	Packing	
3N60ZL-TF3-T	3N60ZG-TF3-T		TO-220F	G	D	S	Tube	
Note: Pin Assignment: G: Gate	D: Drain S: Source							
3N60ZL- <u>TF3-T</u>	(1)Packing Type (2)Package Type (3)Lead Free	(2)	T: Tube TF3: TO-22F G: Halogen Free	, L: Lead	d Free			

Power MOSFET



■ ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	600	V	
Gate-Source Voltage		V _{GSS}	±30	V	
Avalanche Current (Note 2)		I _{AR}	3.0	A	
Continuous Drain Current		I _D	3.0	A	
Pulsed Drain Current (Note 2)		I _{DM}	12	А	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	200	mJ	
	Repetitive (Note 2)	E _{AR}	7.5	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation		PD	34	W	
Junction Temperature		TJ	+150	°C	
Operating Temperature		T _{OPR}	-55 ~ +150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 64mH, I_{AS} = 2.4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 3.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	θ _{JA}	62.5	°C/W
Junction to Case	θ _{JC}	3.68	°C/W

■ ELECTRICAL CHARACTERISTICS (T_c =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	600			V		
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 600V, V _{GS} = 0V			10	μA		
Gate-Source Leakage Current	Forward		$V_{GS} = 30V, V_{DS} = 0V$			100	nA		
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA		
Breakdown Voltage Temperature	Coefficient	$\bigtriangleup BV_{\text{DSS}} / \bigtriangleup T_{\text{J}}$	I _D =250µA, Referenced to 25°C		0.6		V/°C		
ON CHARACTERISTICS									
Gate Threshold Voltage		V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10V, I _D = 1.5A		2.8	3.6	Ω		
DYNAMIC CHARACTERISTICS									
Input Capacitance		C _{ISS}			350	450	рF		
Output Capacitance		Coss	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		50	65	рF		
Reverse Transfer Capacitance		C _{RSS}			5.5	7.5	pF		



■ ELECTRICAL CHARACTERISTICS(Cont.)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
SWITCHING CHARACTERISTICS								
Turn-On Delay Time	t _{D(ON)}			10	30	ns		
Turn-On Rise Time	t _R	$V_{DD} = 300V, I_D = 3.0A,$		30	70	ns		
Turn-Off Delay Time	t _{D(OFF)}	R _G = 25Ω (Note 1, 2)		20	50	ns		
Turn-Off Fall Time	t _F			30	70	ns		
Total Gate Charge	Q_G	V 400V I 0.0A		10	13	nC		
Gate-Source Charge	Q_{GS}	V_{DS} = 480V, I_{D} = 3.0A,		2.7		nC		
Gate-Drain Charge	Q_{DD}	V _{GS} = 10V (Note 1, 2)		4.9		nC		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 3.0A			1.4	V		
Maximum Continuous Drain-Source Diode	Is				3.0	А		
Forward Current	IS				5.0			
Maximum Pulsed Drain-Source Diode	l				12	А		
Forward Current	I _{SM}				12	~		
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V, I_{S} = 3.0A,$		210		ns		
Reverse Recovery Charge	Q _{RR}	dI _F /dt = 100 A/µs (Note 1)		1.2		μC		

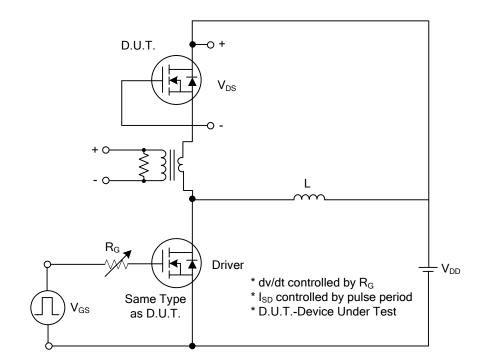
Notes: 1. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%

2. Essentially independent of operating temperature.

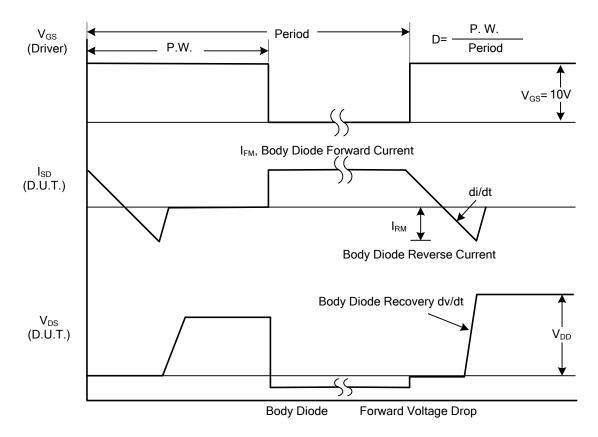


3N60Z

■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit

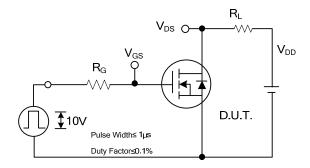




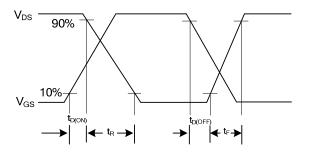


3N60Z

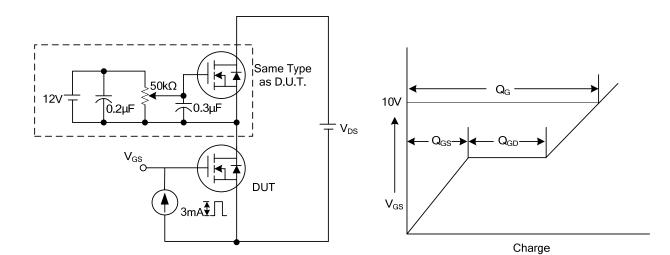
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



Switching Test Circuit

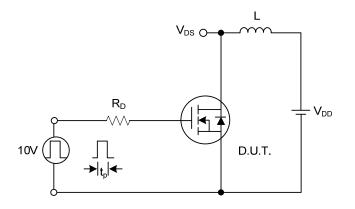


Switching Waveforms

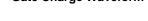


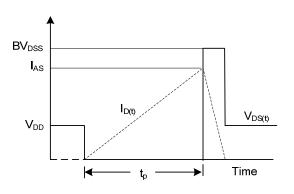
Gate Charge Test Circuit

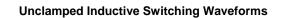
Gate Charge Waveform



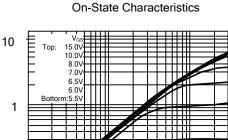
Unclamped Inductive Switching Test Circuit



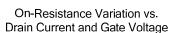


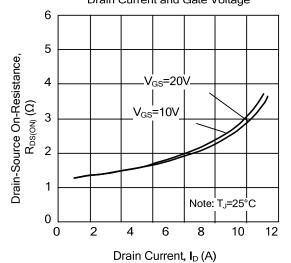


TYPICAL CHARACTERISTICS

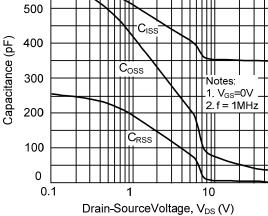


Drain Current, I_D (A) 0.1 Notes: 1. 250µs Pulse Test 2. T_c=25°C ŬШ 0.1 10 Drain-to-Source Voltage, V_{DS} (V)



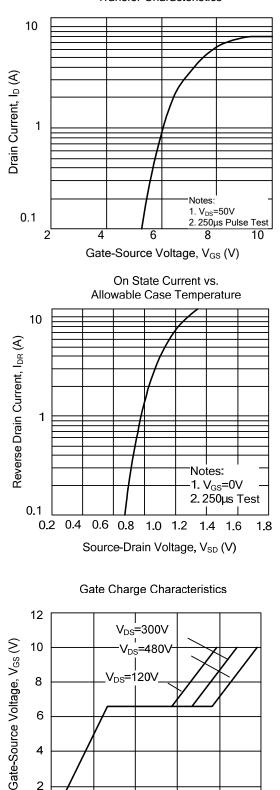


Capacitance Characteristics (Non-Repetitive) ⊢C_{GD} (C_{DS}=shorted)





600



4

2

0

0

Transfer Characteristics

10

Note: I_D=3.0A

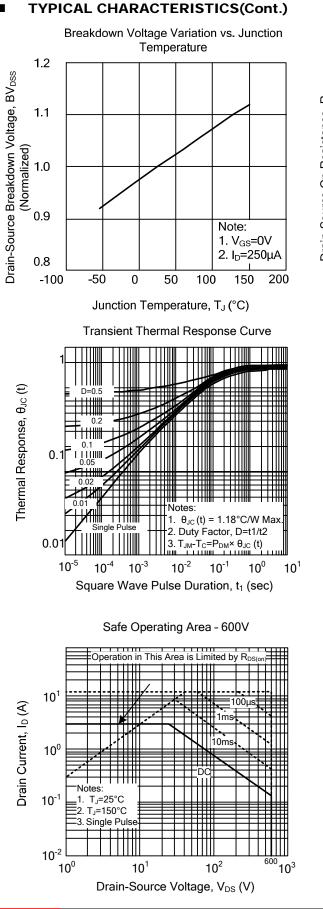
8

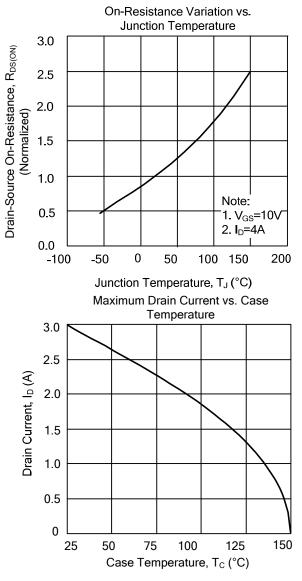
4

2

6

Total Gate Charge, Q_G (nC)





TC UNISONIC TECHNOLOGIES CO., LTD

7 of 8 QW-R502-744.A

UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.

